

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	41	((("20010038065") or ("20020011978") or ("20020044208") or ("20030032210") or ("20050161675") or ("20050167573") or ("5821138") or ("6376333") or ("6891391") or ("20010030704") or ("20020074551") or ("20030032213") or ("20050056842") or ("20050082463") or ("20050195129") or ("20050202609") or ("20050206830") or ("6194740") or ("6287888") or ("6531711")). PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/06/11 21:41
L8	44	(257/52 or 257/53).ccls. and @ad<"20030130" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:07
L10	183	(257/57 or 257/59).ccls. and @ad<"20030130" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:16
L11	1	(257/E29.289).ccls. and @ad<"20030130" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:42
L12	41	(257/E25.01).ccls. and @ad<"20030130" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:43
L13	4	(257/E25.004).ccls. and @ad<"20030130" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:44
L14	142	(257/E25.032).ccls. and @ad<"20030130" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:45
L15	8	(257/E31.096).ccls. and @ad<"20030130" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:52

EAST Search History

L16	190	semiconductor and ((amorphous or "a-si" or "a:si") with active) and ((adhes\$6 or plastic) with (substrate)) and @ad<"20030108" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 22:54
L17	219	semiconductor and ((amorphous or "a-si" or "a:si") with active) and ((\$5crystal or \$5crystalline) with active) and ((adhes\$5 or plastic)) and @ad<"20030108" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 23:16
L18	422	semiconductor and ((amorphous or "a-si" or "a:si") with (active or diode or TFT)) and ((\$5crystal or \$5crystalline) with active) and ((adhes\$5 or plastic)) and @ad<"20030108" and (PCB or PWB or board)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 23:18
L19	9	semiconductor and ((amorphous or "a-si" or "a:si") with (active or diode or TFT)) and ((\$5crystal or \$5crystalline) with active) and ((adhes\$5 or plastic)) and @ad<"20030108" and (((PCB or PWB or board) with (solder or balls)) same (via or pad or bond or plug or wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 23:24
L20	9736	semiconductor and @ad<"20030108" and (((PCB or PWB or board) with (solder or balls)) same (via or pad or bond or plug or wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 23:25
L21	7389	semiconductor and @ad<"20030108" and (((PCB or PWB or board) with (solder or balls)) same (via or plug or wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 23:25
L22	2594	semiconductor and @ad<"20030108" and (((PCB or PWB or board) with (solder or balls)) same ((via or plug or wir\$4) with (pad or bond)))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 23:37
L23	115	(257/758 or 257/774).ccls. and @ad<"20030108" and (((PCB or PWB or board) with (solder or balls)) same ((via or plug or wir\$4) with (pad or bond)))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/06/11 23:38